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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Chun-Yuan LEE

08/15/02

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies)

Name: Inpaq Technology Co., Ltd.

Internal Address: _____

Street Address: No. 59-12, 9 Lin, Ta Tsuo Li,

Chu Nan Chen, Miao Li Hsien

City: _____ State: Taiwan R.O.C. Zip: _____

Additional name(s) & address(es) attached? ☐ Yes ☒ NoJ1046 U.S. PTO
10/219514

3. Nature of conveyance:



Assignment



Merger



Security Agreement



Change of Name



Other _____

Execution Date: August 12, 2002

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: August 12, 2002

A. Patent Application No.(s)

08/19/2002 B5AYAS11 00000011 10219514

02 FD:58

40.00 DP

B. Patent No.(s)

Additional number(s) attached ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: William E. Lahey

Internal Address: _____

Senniger, Powers, Leavitt & Roedel

Street Address: _____

One Metropolitan Square, 16th Floor

City: St. Louis State: MO Zip: 63102

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41).....\$ 40.00



Included with application filing fee



Authorized to be charged to deposit account

8. Deposit account number:

19-1345

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

William E. Lahey

Name of Person Signing

Signature

August 15, 2002

Date

Total number of pages including cover sheet, attachments, and document 3

Mail documents to be recorded with required cover sheet information to:
Commissioner of Patent & Trademarks, Box Assignments
Washington, D.C. 20231

INSTRUCTIONS

ASSIGNMENT OF U.S. RIGHTS TO CORPORATION

WHEREAS.

Inventor(s) Name, Address, Citizenship ▶ 1. CHUN-YUAN LEE residing at NO. 42, LANE 227, MING-HSING ROAD, CHUTUNG, HSINCHU, TAIWAN, R.O.C.
and a citizen of TAIWAN, R.O.C.

2. _____ residing at _____
and a citizen of _____

3. _____ residing at _____
and a citizen of _____

Date Patent Declaration Signed and Title ▶ (herein called "THE UNDERSIGNED") have made an invention and have executed an application for Letters Patent of the United States on _____ for this invention, which application is entitled IC PACKAGE SUBSTRATE WITH OVER VOLTAGE PROTECTION FUNCTION and which has been given

Serial No. and Filing Date ▶ Serial Number _____ and the filing date of _____

Name of Corporation ▶ AND WHEREAS INPAQ TECHNOLOGY CO., LTD. (herein called "ASSIGNEE"), a corporation organized under the laws of TAIWAN, R.O.C. and having an office and place of business at NO. 59-12, 9 LIN, TA TSUO LI, CHU NAN CHEN, MIAO LI HSIEN, TAIWAN, R.O.C.

State or Country of Incorporation and Address ▶ wishes to acquire the entire right, title and interest in and to said invention and patent application and any Letters Patent to be obtained therefor;

NOW, THEREFORE, for and in consideration of the sum of One Dollar and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, THE UNDERSIGNED hereby sell, assign and transfer to the ASSIGNEE, its successors and assigns, the entire right, title and interest for the United States in and to the invention disclosed in the aforesaid application, and in and to the said application, all divisions, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and THE UNDERSIGNED hereby authorize and request the Commissioner of Patents to issue any and all United States Letters Patent for the aforesaid invention to the ASSIGNEE of the entire right, title and interest in and to the same, for the use of the ASSIGNEE, its successors and assigns.

THE UNDERSIGNED hereby agree that THE UNDERSIGNED, their executors and legal representatives will make, execute and deliver (without charge but at the expense of the ASSIGNEE) any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said ASSIGNEE, its successors and representatives all facts known to THE UNDERSIGNED relating to said invention and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable to vest the ASSIGNEE, its successors or assigns the entire right, title and interest in and to the said invention, applications, Letters Patent, rights, titles, benefits, privileges and advantages hereby sold, assigned and conveyed, or intended so to be.

THE UNDERSIGNED represent and agree with said ASSIGNEE, its successors and assigns, that no assignment grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by THE UNDERSIGNED, and that full right to convey the same as herein expressed is possessed by THE UNDERSIGNED.

IN TESTIMONY WHEREOF, THE UNDERSIGNED have hereunto set their hand on the dates indicated below.

Each Inventor Must Sign and Date

X Chun-Yuan Lee
Signature CHUN-YUAN LEE

AUGUST 12, 2002

Date

Note: No Legalization or Other Witness Required

Signature

Date

Signature

Date

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